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Attorney Docket No. 108298872US Disclosure No. 05-1106.00/US

U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

OMB No. 0651-0027 (exp. 6/30/2008) 103300440 To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below. 2. Name and address of receiving party(ies) 1. Name of conveying party(ies): Chin Hui Chong (8/22/2006), Choon Kuan Lee Micron Technology, Inc. (8/22/2006), and David J. Corisis (8/21/2006) Internal Address: Additional name(s) of conveying party(ies) attached? Yes Street Address: 3. Nature of conveyance/Execution Date(s): 8000 South Federal Way Execution Date(s): in parentheses after inventor name P.O. Box 6 x Assignment Merger Change of Name Joint Research Agreement Security Agreement Government Interest Assignment State: Executive Order 9424, Confirmatory License Country: __United States of America Zip: 83716-9632 Additional name(s) & address(es) attached? 4. Application or patent number(s): x This document is being filed together with a new application. A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached? Yes 5. Name and address to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: John M. Wechkin 40.00 PERKINS COIE LLP 7. Total fee (37 CFR 1.21(h) & 3.41) \$ Internal Address: Atty. Dkt.: 108298872US Authorized to be charged by credit card Street Address: P.O. Box 1247 Authorized to be charged to deposit account 08/28/2006 HDEMESSI 00000016 11509291 Enclosed 40.00 OP None required (government interest not affecting title) City: 8. Payment Information Zip: 98111-1247 a. Credit Card Last 4 Numbers State: **Expiration Date** Phone Number: (206) 359-8000 (206) 359-9000 b. Deposit Account Number Fax Number: Authorized User Name Email Address: 9. Signatyre: August 23, 2006 Signature

John M. Wechkin - 42,216

Name of Person Signing

Total number of pages including cover

sheet, attachments, and documents:

REEL: 018214 FRAME: 0320

ASSIGNMENT

THIS ASSIGNMENT is by Chin Hui Chong, Choon Kuan Lee and David J. Corisis (the "Assignors"), residing at Block 10H, #07-29, Braddell View, Braddell Hill, Singapore 579727; Block 108, Simei Street 1, #07-756, Singapore 520108; and 4903 Stamm Lane, Nampa, Idaho 83687, respectively. We Assignors have invented one or more certain inventions (the "Invention(s)") described in a United States Patent Application entitled "MICROELECTRONIC PACKAGES WITH LEADFRAMES, INCLUDING LEADFRAMES CONFIGURED FOR STACKED DIE PACKAGES, AND ASSOCIATED SYSTEMS AND METHODS" and X executed concurrently herewith; or ______ filed on ______ as Application No. ______ we Assignors authorize the Assignee, identified below, or its representatives to insert the application number of the Application when known.

Micron Technology, Inc., a corporation of the State of Delaware having a place of business at 8000 South Federal Way, P.O. Box 6, Boise, Idaho 83716-9632 ("Assignee"), desires to acquire the entire right, title and interest in and to the Invention(s) and the Application, and in and to any patents (collectively, "Patents") that may be granted for the Invention(s) in the United States or in any foreign countries.

For valuable consideration, the receipt and sufficiency of which we acknowledge, Assignors hereby sell, assign, and transfer to Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to: the Invention(s), the Application, and any Patents; any divisions, continuations, and continuations-in-part of the Application and any other application claiming priority rights from the Application; any reissues, reexaminations, or extensions of any and all Patents; the right to file foreign applications directly in the name of Assignee; and the right to claim priority rights deriving from the Application (collectively, the "Rights"). Assignors warrant that they are joint owners of the Rights, and that the Rights are unencumbered. Assignors also agree to not sign any writing or do any act conflicting with this assignment, and, without further compensation, sign all documents and do such additional acts as Assignee deems necessary or desirable to: perfect Assignee's enjoyment of the Rights; prepare and prosecute the Application or any other applications for Patents; conduct proceedings regarding the Rights, including any litigation or interference proceedings; or perfect or defend title to the Rights. Assignors request the Commissioner of Patents to issue any Patent of the United States that may be issued on the Invention(s) to Assignee. Assignment may be executed in counterparts.

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PATENT REEL: 018214 FRAME: 0321

Date: 22 mg 2006			
\	Choon Kuan Lee		
WITNESS TO SIGNATURE BY Choon Kuan Lee			
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Signature	Date		
Wang Ai-Chie			
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Page 2

Date:	8/21/06	Oan J	an.
	7 7	David J. Corisis	

STATE OF Idaho

On August 2 1st 2006 before me, Weather Kelly-Sm:th, personally appeared David J. Corisis, personally known to me (or proved to me on the basis of satisfactory evidence) to be the person whose name is subscribed to the within instrument and acknowledged to me that he/she executed the same in his/her authorized capacity, and that by his/her signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

WITNESS my hand and official seal.